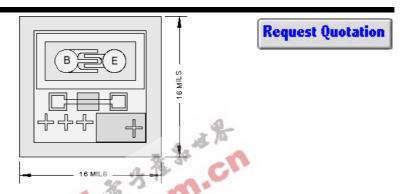


Data Sheet No. 2C2857

Chip Type 2C2857 Geometry 0011 Polarity NPN **Generic Packaged Part:**

2N2857



Chip type **2C2857** by Semicoa Semiconductors provides performance similar to these devices.

Part Numbers:

2N2857, 2N2857UB, SD2857, SD2857F, SQ2857, SQ2857F

Product Summary:

APPLICATIONS: Designed for use in high-gain, low noise amplifier, oscillator, mixer and UHF converters.

Features: ft = 1.2 GHz (typ) at 5 mA/6V

Mechanical Specifications					
Metallization	Тор	Al - 15 kÅ min.			
	Backside	Au - 6.5 kÅ nom.			
Danding Dad Sign	Emitter	2.3 mils x 2.3 mils			
Bonding Pad Size	Base	2.3 mils x 2.3 mils			
Die Thickness	8 mils nominal				
Chip Area	16 mils x 16 mils				
Top Surface	Silox Passivated				

Electrical Characteristics T _A = 25°C						
Parameter	Test conditions	Min	Max	Unit		
BV _{CEO}	$I_C = 3.0 \text{ mA}$	15		V dc		
BV _{CBO}	$I_{\rm C} = 1.0 \mu A$	30		V dc		
BV_{EBO}	$I_E = 10 \mu A$	2.5		V dc		
I _{CBO}	V _{CB} = 15 V		0.01	μA dc		
h _{FE}	$I_{\rm C} = 3.0 \text{ mA dc}, V_{\rm CE} = 1.0 \text{ V}$	30	150			

Due to limitations of probe testing, only dc parameters are tested. This must be done with pulse width of less than 300 µs, duty cycle less than 2%.